



SLV3407T -30V P -Channel MOSFET

General Description

This Power MOSFET is produced using Msemitek's advanced TRENCH technology.

This advanced technology has been especially tailored to minimize conduction loss, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

Application

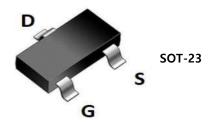
- ☑ PWM Application
- ☑ Load Switch
- ☑ Power Management

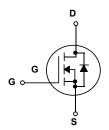
Features

- P-Channel: -30V -4.1A

$$\begin{split} R_{DS(on)Typ} &= 36m\Omega@V_{GS} = -10V \\ R_{DS(on)Typ} &= 52m\Omega@V_{GS} = -4.5V \end{split}$$

- Very Low On-resistance R_{DS(ON)}
- Low Crss
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability





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Absolute Maximum Ratings $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	SLV3407T	Units	
V_{DSS}	Drain-Source Voltage	-30	V	
1	Drain Current - Continuous (T _C = 25°C)	-4.1	А	
l _D	- Continuous (T _C = 70°C)	-3.2	Α	
І _{рм}	Drain Current - Pulsed (Note 1)	-15	Α	
V _{GSS}	Gate-Source Voltage	±20	V	
Б	Power Dissipation (T _A = 25°C)	1.2	w	
P _D	Power Dissipation (T _A =70°C)	0.8		
R _{θJA}	Thermal Resistance, Junction to Case	105	°C/W	
T_J,T_{STG}	Operating and Storage Temperature Range	-55 to +150	ဇ	
T∟	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	ဇ	

^{*} Drain current limited by maximum junction temperature.

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					

BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D =- 250 uA	-30	1	I	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30 V, V _{GS} = 0 V	1	1	-1.0	uA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20V, V _{DS} = 0 V	1	1	-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20 V, V _{DS} = 0 V			100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \text{ uA}$	-1	-1.5	-2.4	٧
В	Static Drain-Source On-Resistance	V _{GS} =-10 V, I _D =- 4.1A	1	36	49	mΩ
R _{DS(on)}		V _{GS} =-4.5V, I _D = -3.5A	1	52	65	mΩ

Dynamic Characteristics

Ciss	Input Capacitance		-	572	-	pF
Coss	Output Capacitance	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		82	-	pF
C_{rss}	Reverse Transfer Capacitance	1.5 1/11/2		70	-	рF

Switching Characteristics

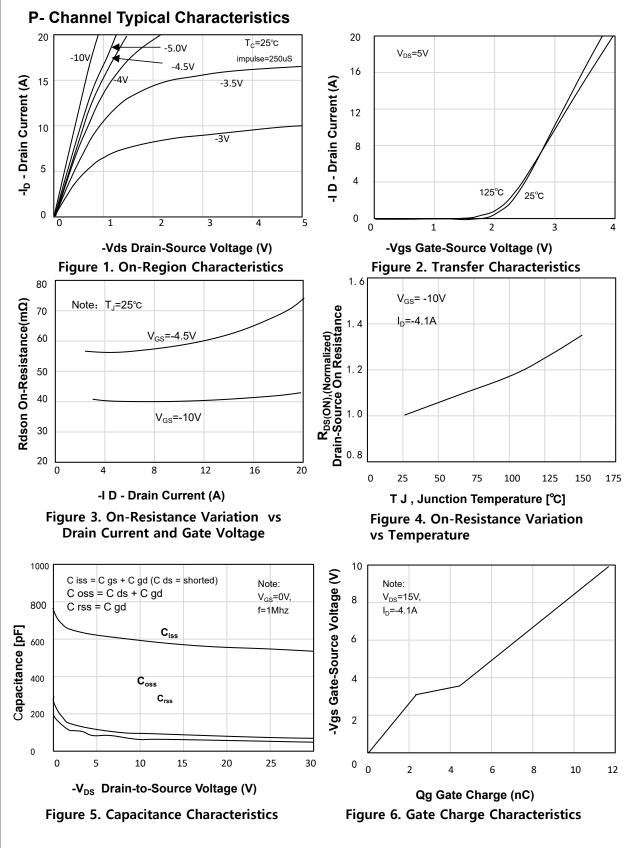
$t_{\sf d(on)}$	Turn-On Delay Time	V_{GS} =-10V, V_{DS} =-15 V, R_{G} = 2.5 Ω , R_{L} =15 Ω		3.8		ns
t _r	Turn-On Rise Time		-	17.6		ns
$t_{\text{d(off)}}$	Turn-Off Delay Time			17.8		ns
t _f	Turn-Off Fall Time		-	21.8		ns
Q_g	Total Gate Charge	V _{DS} = -15 V, I _D =-4.1A, V _{GS} = -10V		11.65		nC
Q_{gs}	Gate-Source Charge		-	2.32	-	nC
Q_{gd}	Gate-Drain Charge		-	2.08	-	nC
Qrr	Reverse Recovery Chrage	I _F =-10A, di/dt=100A/us		0.643		nC
t _{rr}	Reverse Recovery Time	I _F =-10A, di/dt=100A/us		15.7		ns

Drain-Source Diode Characteristics and Maximum Ratings

Is	Is Maximum Continuous Drain-Source Diode Forward Current			-4.1	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current			-16	Α
V_{SD}	Drain to Source Diode Forward Voltage, V GS = 0V, I _{SD} =-4.1A, T J = 25°C			-1.2	V

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- 2. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



P- Channel Typical Characteristics (Continued)

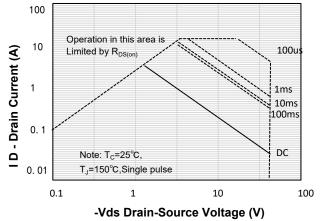


Figure 7. Maximum Safe Operating Area

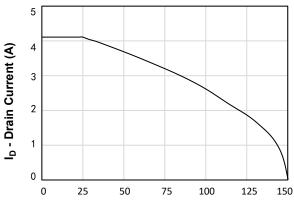


Figure 8. Maximum Continuous Drain Currentvs Temperature

T J -Junction Temperature(°C)

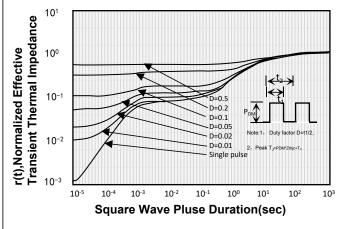
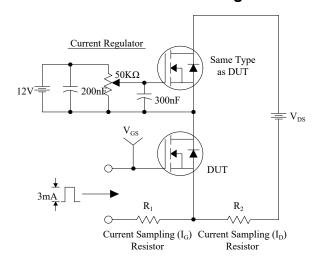
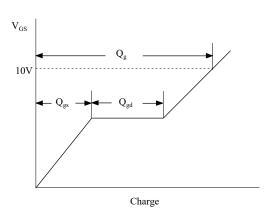


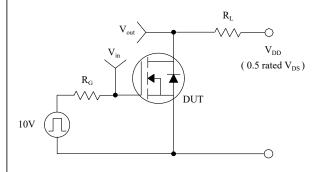
Figure 9. Transient Thermal Response Curve

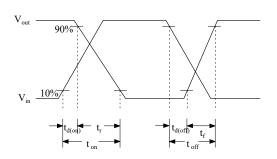
Gate Charge Test Circuit & Waveform



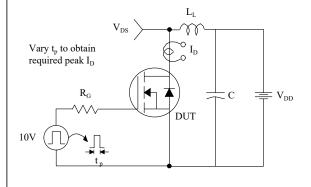


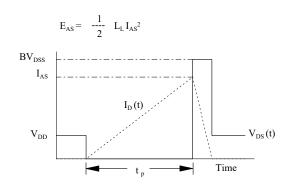
Resistive Switching Test Circuit & Waveforms



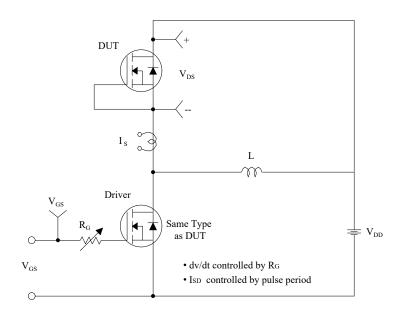


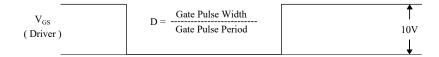
Unclamped Inductive Switching Test Circuit & Waveforms

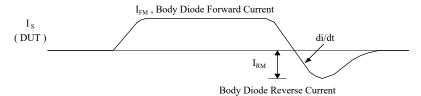


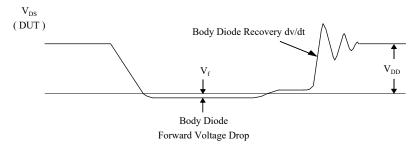


Peak Diode Recovery dv/dt Test Circuit & Waveforms









SOT-23 OUTLINE 2.800-3.000 0.300-0.500 100 0.9500 1.800-2.000 0.080-0.150 0.001-0.100 NOTE:

1The plastic package is not marked as smooth surfaceRa=0.1; Subglossy surfaceRa=0.8

2.Undeclared tolerance ± 0.25, Unmarked filletRmax=0.25

NAME	SOT-23 OUTLINE	UNIT	mm	DESIGNED	Shawn	THIRD ANGLE SYSTEM
DWGNO		PAGE	1 OF 1	CHECKED		*
VERSION	Ver1.0	ISSUE DATE		APPROVED		

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